PRELIMINARY

V29C51000T/V29C51000B 512K BIT (65,536 x 8 BIT) 5 VOLT CMOS FLASH MEMORY

Features

- 64Kx8-bit Organization
- Address Access Time: 45, 70, 90 ns
- Single 5V ± 10% Power Supply
- Sector Erase Mode Operation
- 8KB Boot Block (lockable)
- 512 bytes per Sector, 128 Sectors
 - Sector-Erase Cycle Time: 10ms (Max)
 - Byte-Program Cycle Time: 20μs (Max)
- Minimum 10,000 Erase-Program Cycles
- Low power dissipation
 - Active Read Current: 20mA (Typ)
 - Active Program Current: 30mA (Typ)
 - Standby Current: 100μA (Max)
- Hardware Data Protection
- Low V_{CC} Program Inhibit Below 3.2V
- Self-timed program/erase operations with endof-cycle detection
 - DATA Polling
 - Toggle Bit
- CMOS and TTL Interface
- Available in two versions
 - V29C51000T (Top Boot Block)
 - V29C51000B (Bottom Boot Block)
- Packages:
 - 32-pin Plastic DIP
 - 32-pin TSOP-I
 - 32-pin PLCC

Description

The V29C51000T/V29C51000B is a high speed 65,536 x 8 bit CMOS flash memory. Programming or erasing the device is done with a single 5 Volt power supply. The device has separate chip enable CE, program enable $\overline{\rm WE}$, and output enable $\overline{\rm OE}$ controls to eliminate bus contention.

The V29C51000T/V29C51000B offers a combination of features: Boot Block with Sector Erase Mode. The end of program/erase cycle is detected by $\overline{\text{DATA}}$ Polling of I/O₇ or by the Toggle Bit I/O₆.

The V29C51000T/V29C51000B features a sector erase operation which allows each sector to be erased and reprogrammed without affecting data stored in other sectors. The device also supports full chip erase.

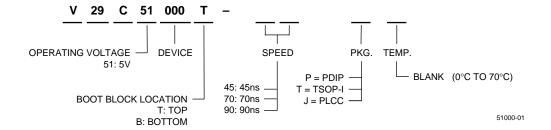
Boot block architecture enables the device to boot from either the top (V29C51000T) or bottom (V29C51000B) sector. All inputs and outputs are CMOS and TTL compatible.

The V29C51000T/V29C51000B is ideal for applications that require updatable code and data storage.

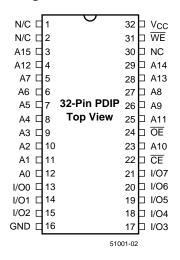
Device Usage Chart

Operating	Pa	ickage Outli	ne	Ac	cess Time (Tomporoturo		
Temperature Range	Р	т	J	45	70	90	Temperature Mark	
0°C to 70°C	•	•	•	•	•	•	Blank	

V29C51000T/V29C51000B

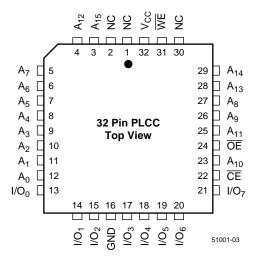


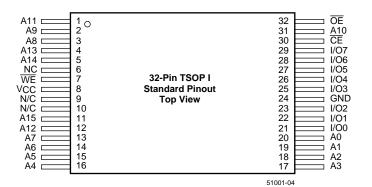
Pin Configurations



Pin Names

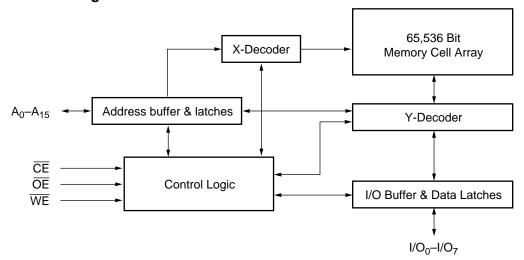
I/O_0 - I/O_7 Data Input/Output \overline{CE} Chip Enable \overline{OE} Output Enable \overline{WE} Program Enable V_{CC} $5V \pm 10\%$ Power SupplyGNDGroundNCNo Connect	A ₀ -A ₁₅	Address Inputs
OE Output Enable WE Program Enable V _{CC} 5V ± 10% Power Supply GND Ground	I/O ₀ –I/O ₇	Data Input/Output
WE Program Enable V _{CC} 5V ± 10% Power Supply GND Ground	CE	Chip Enable
V _{CC} 5V ± 10% Power Supply GND Ground	ŌĒ	Output Enable
GND Ground	WE	Program Enable
	V_{CC}	5V ± 10% Power Supply
NC No Connect	GND	Ground
	NC	No Connect





V29C51000T/V29C51000B

Functional Block Diagram



Capacitance (1,2)

Symbol	Parameter	Test mSetup	Тур.	Max.	Units
C _{IN}	Input Capacitance	V _{IN} = 0	6	8	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0	8	12	pF
C _{IN2}	Control Pin Capacitance	V _{IN} = 0	8	10	pF

NOTE:

- 1. Capacitance is sampled and not 100% tested.
- 2. $T_A = 25^{\circ}C$, $V_{CC} = 5V \pm 10\%$, f = 1 MHz.

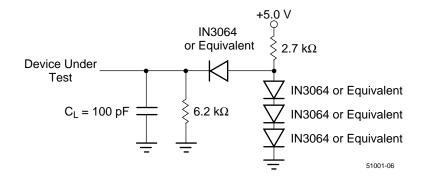
Latch Up Characteristics⁽¹⁾

Parameter	Min.	Max.	Unit
Input Voltage with Respect to GND on A ₉ , $\overline{\text{OE}}$	-1	+13	V
Input Voltage with Respect to GND on I/O, address or control pins	-1	V _{CC} + 1	V
V _{CC} Current	-100	+100	mA

NOTE

1. Includes all pins except V_{CC} . Test conditions: $V_{CC} = 5V$, one pin at a time.

AC Test Load



V29C51000T/V29C51000B

Absolute Maximum Ratings⁽¹⁾

Symbol	Parameter	Commercial	Unit
V _{IN}	Input Voltage (input or I/O pins)	-2 to +7	V
V _{IN}	Input Voltage (A ₉ pin, $\overline{\text{OE}}$)	-2 to +13	V
V _{CC}	Power Supply Voltage	-0.5 to +5.5	V
T _{STG}	Storage Temerpature (Plastic)	-65 to +125	°C
T _{OPR}	Operating Temperature	0 to +70	°C
I _{OUT}	Short Circuit Current ⁽²⁾	200 (Max.)	mA

NOTE:

DC Electrical Characteristics

(over the commercial operating range)

Parameter Name	Parameter	Test Conditions	Min.	Max.	Unit
V _{IL}	Input LOW Voltage	V _{CC} = V _{CC} Min.	_	0.8	V
V _{IH}	Input HIGH Voltage	V _{CC} = V _{CC} Max.	2	_	V
I _{IL}	Input Leakage Current	$V_{IN} = GND$ to V_{CC} , $V_{CC} = V_{CC}$ Max.	_	±1	μΑ
I _{OL}	Output Leakage Current	$V_{OUT} = GND$ to V_{CC} , $V_{CC} = V_{CC}$ Max.	_	±1	μΑ
V _{OL}	Output LOW Voltage	V _{CC} = V _{CC} Min., I _{OL} = 2.1mA	_	0.4	V
V _{OH}	Output HIGH Voltage	V _{CC} = V _{CC} Min, I _{OH} = -400μA	2.4	_	V
I _{CC1}	Read Current	$\overline{\text{CE}} = \overline{\text{OE}} = \text{V}_{\text{IL}}, \overline{\text{WE}} = \text{V}_{\text{IH}}, \text{ all I/Os open},$ Address input = $\text{V}_{\text{IL}}/\text{V}_{\text{IH}}, \text{ at f} = \text{1/t}_{\text{RC}} \text{ Min.},$ $\text{V}_{\text{CC}} = \text{V}_{\text{CC}} \text{ Max.}$	_	40	mA
I _{CC2}	Program Current	$\overline{CE} = \overline{WE} = VIL, \overline{OE} = V_{IH}, V_{CC} = V_{CC} Max.$	_	50	mA
I _{SB}	TTL Standby Current	$\overline{CE} = \overline{OE} = \overline{WE} = V_{IH}, V_{CC} = V_{CC} Max.$	_	2	mA
I _{SB1}	CMOS Standby Current	$\overline{CE} = \overline{OE} = \overline{WE} = V_{CC} - 0.3V, V_{CC} = V_{CC} Max.$	_	100	μΑ
V _H	Device ID Voltage for A ₉	$\overline{CE} = \overline{OE} = V_{IL}, \overline{WE} = V_{IH}$	11.5	12.5	V
I _H	Device ID Current for A ₉	$\overline{CE} = \overline{OE} = V_{IL}, \overline{WE} = V_{IH}, A9 = V_{H} Max.$	_	50	μΑ

Stress greater than those listed unders "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress
rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections
of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

^{2.} No more than one output maybe shorted at a time and not exceeding one second long.

V29C51000T/V29C51000B

AC Electrical Characteristics

(over all temperature ranges)

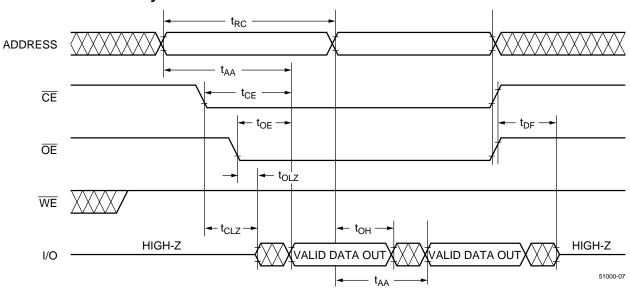
Read Cycle

Parameter			1 5	-70		-90		
Name	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
t _{RC}	Read Cycle Time	45	_	70	_	90	_	ns
t _{AA}	Address Access Time	_	45	_	70	_	90	ns
t _{ACS}	Chip Enable Access Time	_	45	_	70	_	90	ns
t _{OE}	Output Enable Access Time	_	25	_	35	_	45	ns
t _{CLZ}	CE Low to Output Active	0	_	0	_	0	_	ns
t _{OLZ}	OE Low to Output Active	0	_	0	_	0	_	ns
t _{DF}	Output Enable or Chip Disable to Output in High Z	0	20	0	20	0	30	ns
t _{OH}	Output Hold from Address Change	0	_	0	_	0	_	ns

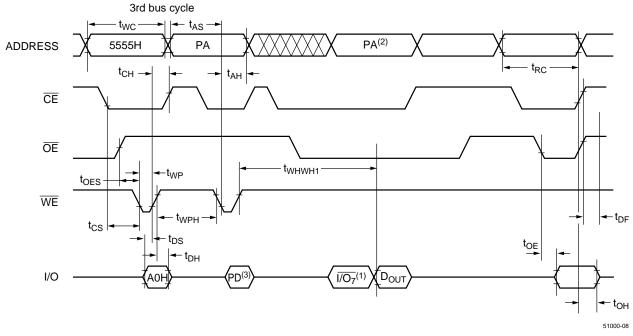
Program (Erase/Program) Cycle

Parameter			-45			-70		-90			
Name	Parameter		Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
t _{WC}	Program Cycle Time	45	_	_	70	_	_	90	_	_	ns
t _{AS}	Address Setup Time	0	_	_	0	_	_	0	_	_	ns
t _{AH}	Address Hold Time	35	_	_	45	_	_	45	_	_	ns
t _{CS}	CE Setup Time	0	_	_	0	_	_	0	_	_	ns
t _{CH}	CE Hold Time	0	_	_	0	_	_	0	_	_	ns
toes	OE Setup Time	0	_	_	0	_	_	0	_	_	ns
t _{OEH}	OE High Hold Time	0	_	_	0	_	_	0	_	_	ns
t _{WP}	WE Pulse Width	25	_	_	35	_	_	45	_	_	ns
t _{WPH}	WE Pulse Width High	20	_	_	35	_	_	38	_	_	ns
t _{DS}	Data Setup Time	20	_	_	25	_	_	30	_	_	ns
t _{DH}	Data Hold Time	0	_	_	0	_	_	0	_	_	ns
t _{WHWH1}	Programming Cycle	_	_	20	_	_	20	_	_	20	μs
t _{WHWH2}	Sector Erase Cycle	_	_	10	_	_	10	_	_	10	ms
t _{WHWH3}	Chip Erase Cycle	_	500	_	_	500	_	_	500	_	ms

Waveforms of Read Cycle



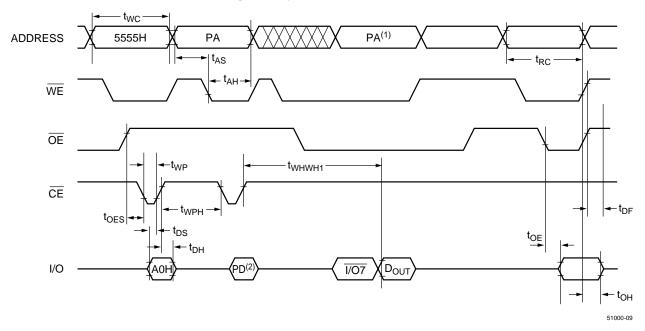
Waveforms of WE Controlled-Program Cycle



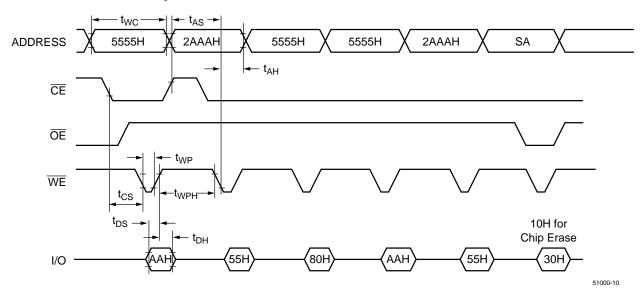
NOTES:

- 1. I/O₇: The output is the complement of the data written to the device.
- 2. PA: The address of the memory location to be programmed.
- 3. PD: The data at the byte address to be programmed.

Waveforms of CE Controlled-Program Cycle



Waveforms of Erase Cycle⁽¹⁾

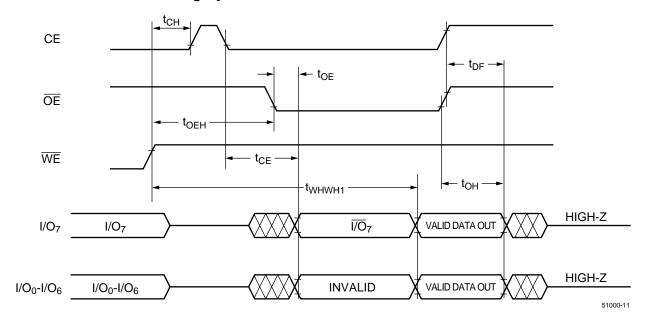


NOTES:

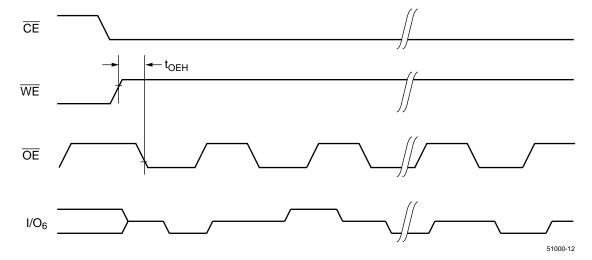
- 1. PA: The address of the memory location to be programmed.
- 2. PD: The data at the byte address to be programmed.
- 3. SA: The sector address for Sector Erase. Address = don't care for Chip Erase.

V29C51000T/V29C51000B

Waveforms of DATA Polling Cycle



Waveforms of Toggle Bit Cycle



V29C51000T/V29C51000B

V29C51000B

Functional Description

The V29C51000T/V29C51000B consists of 256 equally-sized sectors of 512 bytes each. The 8 KB lockable Boot Block is intended for storage of the system BIOS boot code. The boot code is the first piece of code executed each time the system is powered on or rebooted.

The V29C51000 is available in two versions: the V29C51000T with the Boot Block address starting from E000H to FFFFH, and the V29C51000B with the Boot Block address starting from 0000H to FFFFH.

Read Cycle

A read cycle is performed by holding both $\overline{\text{CE}}$ and $\overline{\text{OE}}$ signals LOW. Data Out becomes valid only when these conditions are met. During a read cycle $\overline{\text{WE}}$ must be HIGH prior to $\overline{\text{CE}}$ and $\overline{\text{OE}}$ going LOW. $\overline{\text{WE}}$ must remain HIGH during the read operation for the read to complete (see Table 1).

Output Disable

Returning \overline{OE} or \overline{CE} HIGH, whichever occurs first will terminate the read operation and place the I/O pins in the HIGH-Z state.

Standby

The device will enter standby mode when the $\overline{\text{CE}}$ signal is HIGH. The I/O pins are placed in the HIGH-Z, independent of the $\overline{\text{OE}}$ signal.

Command Sequence

The V29C51000T/V29C51000B does not provide the "reset" feature to return the chip to its normal state when an incomplete command sequence or an interruption has happened. In this case, normal operation (Read Mode) can be restored by issuing a "non-existent" command sequence, for example Address: 5555H, Data FFH.

Table 1. Operation Modes Decoding

	_		
8KB Boot Block	FFFFH E000H		512
512			
512			•
			•
•			
			512
		455511	512
512	0000H	1FFFH 0000H	8KB Boot Block
		2300	

51000-13

8KB Boot Block = 16 Sectors

Byte Program Cycle

V29C51000T

The V29C51000T/V29C51000B is programmed on a byte-by-byte basis. The byte program operation is initiated by using a specific four-bus-cycle sequence: two unlock program cycles, a program setup command and program data program cycles (see Table 2).

During the byte program cycle, addresses are latched on the falling edge of either $\overline{\text{CE}}$ or $\overline{\text{WE}}$, whichever is last. Data is latched on the rising edge of $\overline{\text{CE}}$ or $\overline{\text{WE}}$, whichever is first. The byte program cycle can be $\overline{\text{CE}}$ controlled or $\overline{\text{WE}}$ controlled.

Sector Erase Cycle

The V29C51000T/V29C51000B features a sector erase operation which allows each sector to be erased and reprogrammed without affecting data stored in other sectors. Sector erase operation is initiated by using a specific six-bus-cycle sequence: Two unlock program cycles, a setup command, two additional unlock program cycles, and the sector erase command (see Table 2). A sector must be first erased before it can be reprogrammed. While in the internal erase mode,

Decoding Mode	CE	ŌĒ	WE	A ₀	A ₁	A ₉	I/O
Read	V _{IL}	V _{IL}	V _{IH}	A ₀	A ₁	A ₉	READ
Program	V _{IL}	V _{IH}	V _{IL}	A ₀	A ₁	A ₉	PD
Standby	V _{IH}	X	X	X	X	X	HIGH-Z
Autoselect Device ID	V _{IL}	V _{IL}	V _{IH}	V _{IH}	V _{IL}	V _H	CODE
Autoselect Manufacture ID	V _{IL}	V _{IL}	V _{IH}	V_{IL}	V _{IL}	V _H	CODE
Output Disable	V _{IL}	V _{IH}	V _{IH}	Х	Х	Х	HIGH-Z

NOTES:

- X = Don't Care, V_{IH} = HIGH, V_{IL} = LOW.
- 2. PD: The data at the byte address to be programmed.

Table 2. Command Codes

Command	First Bus Program	Cycle	Second B Program		Third Bus Program		Fourth Bus Program Cycle		Fifth Bus Program Cycle		Six Bus Program Cycle	
Sequence	Address	Data	Address	Data	Address	Data	Address	Data	Address	Data	Address	Data
Read	XXXXH	F0H										
Read	5555H	AAH	2AAAH	55H	5555H	F0H	RA	RD				
Autoselect	5555H	ААН	2AAAH	55H	5555H	90H	00H	40H				
							01H	00H ⁽¹⁾ A0H ⁽²⁾				
Byte Program	5555H	AAH	2AAAH	55H	5555H	A0H	PA	PD(4)				
Chip Erase	5555H	AAH	2AAAH	55H	5555H	80H	5555H	AAH	2AAAH	55H	5555H	10H
Sector Erase	5555H	ААН	2AAAH	55H	5555H	80H	5555H	AAH	2AAAH	55H	PA(3)	30H

NOTES:

- 1. Top Boot Sector
- 2. Bottom Boot Sector
- 3. PA: The address of the memory location to be programmed.
- 4. PD: The data at the byte address to be programmed.

the device ignores any program attempt into the device. The internal erase completion can be determined via DATA polling or toggle bit.

The V29C51000T/V29C51000B is shipped with pre-erased sectors (all bits = 1).

Chip Erase Cycle

The V29C51000T/V29C51000B features a chiperase operation. The chip erase operation is initiated by using a specific six-bus-cycle sequence: two unlock program cycles, a setup command, two additional unlock program cycles, and the chip erase command (see Table 2).

The chip erase operation is performed sequentially, one sector at a time. When the automated on chip erase algorithm is requested with the chip erase command sequence, the device automatically programs and verifies the entire memory array for an all zero pattern prior to erasure

The automatic erase begins on the rising edge of the last $\overline{\text{WE}}$ or $\overline{\text{CE}}$ pulse in the command sequence and terminates when the data on DQ7 is "1".

Program Cycle Status Detection

There are two methods for determining the state of the V29C51000T/V29C51000B during a program (erase/program) cycle: \overline{DATA} Polling (I/O₇) and Toggle Bit (I/O₆).

DATA Polling (I/O₇)

The V29C51000T/V29C51000B features DATA polling to indicate the end of a program cycle. When the device is in the program cycle, any

attempt to read the device will received the complement of the loaded data on I/O_7 . Once the program cycle is completed, I/O_7 will show true data, and the device is then ready for the next cycle.

Toggle Bit (I/O₆)

The V29C51000T/V29C51000B also features another method for determining the end of a program cycle. When the device is in the program cycle, any attempt to read the device will result in I/O_6 toggling between 1 and 0. Once the program is completed, the toggling will stop. The device is then ready for the next operation. Examining the toggle bit may begin at any time during a program cycle.

Boot Block Protection

The V29C51000T/V29C51000B features hardware Boot Block Protection. This feature will prevent erasing/programming of data in the Boot Block once the feature is enabled (see Table 3). The device is shipped with the Boot Block unprotected.

Autoselect

The V29C51000T/V29C51000B features an Autoselect mode to identify the Boot Block (protected/unprotected), the Device (Top/Bottom), and the manufacturer ID.

To get to the Autoselect mode, a high voltage (V_H) must be applied to the A_9 pin. Once the A_9 signal is returned to LOW or HIGH, the device will return to the previous mode.

V29C51000T/V29C51000B

Boot Block Detection

In Autoselect mode, performing a read at address 3CXX2H or address 0CXX2H will indicate if the Top Boot Block sector or the Bottom Boot Block sector is locked out. If the data is 01H, the Top/Bottom Boot Block is protected. If the data is 00H, the Top/Bottom Boot Block is unprotected. (see Table 3.)

Device ID

In Autoselect mode, performing a read at address XXXXH will determine whether the device is a Top Boot Block device or a Bottom Boot Block device. If the data is 00H, the device is a Top Boot Block. If the data is A0H, the device is a Bottom Boot Block device (see Table 3).

In addition, the device ID can also be read via the command register when the device is erased or programmed in a system without applying high voltage to the A_9 pin. When A_0 is HIGH, the device ID is presented at the outputs.

Manufacturer ID

In Autoselect mode, performing a read at address. XXXX0H will determine the manufacturer ID. 40H is the manufacturer code for Mosel Vitelic Flash.

In addition the manufacturer ID can also be read via the command register when the device is erased or programmed in a system without applying high voltage to the A_9 pin. when A_0 is LOW, the manufacturer ID is presented at the outputs.

Hardware Data Protection

 V_{CC} Sense Protection: the program operation is inhibited when VCC is less than 2.5V.

Noise Protection: a CE or WE pulse of less than 5ns will not initiate a program cycle.

Program Inhibit Protection: holding any one of OE LOW, CE HIGH or WE HIGH inhibits a program cycle.

Table 3. Autoselect Decoding

			Add			
Decoding Mode	Boot Block	A ₀	A ₁	A ₂ -A ₁₃	A ₁₄ -A ₁₇	Data I/O ₀ -I/O ₇
Boot Block Protection	Тор	V _{IL}	V _{IH}	Х	V _{IH}	01H: protected
	Bottom	V _{IL}	V _{IH}	Х	V _{IL}	00H: unprotected
Device ID	Тор	V _{IH}	V _{IL}	Х	Х	01H
	Bottom					00H
Manufacture ID		V _{IL}	V _{IL}	Х	Х	A0H

NOTE:

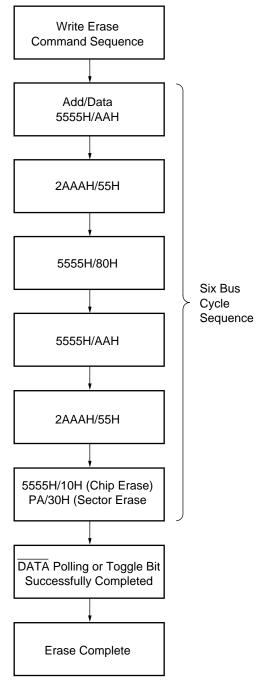
^{1.} $X = Don't Care, V_{IH} = HIGH, V_{IL} = LOW.$

V29C51000T/V29C51000B

Byte Program Algorithm

Write Program Command Sequence Add/Data 5555H/AAH 2AAAH/55H Four Bus Cycle Sequence 5555H/A0H PA/PD DATA Polling (I/O7) or Toggle Bit (I/O6) No Verify Byte? Yes Programming Completed

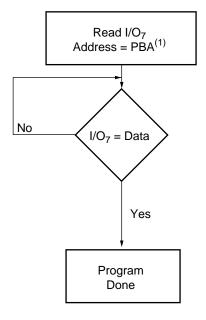
Chip/Sector Erase Algorithm



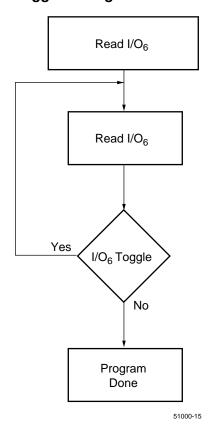
51000-14

V29C51000T/V29C51000B

DATA Polling Algorithm



Toggle Bit Algorithm



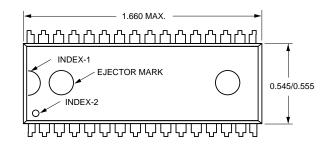
NOTE:

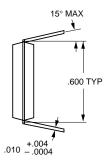
1. PBA: The byte address to be programmed.

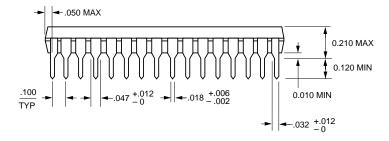
V29C51000T/V29C51000B

Package Diagrams

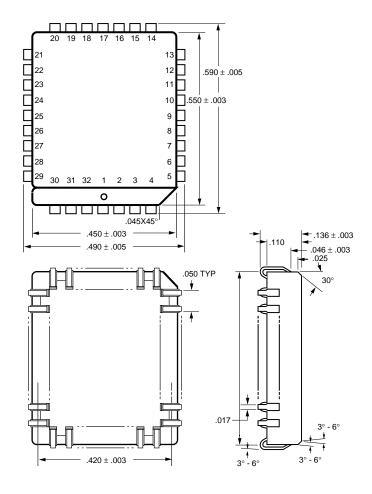
32-pin Plastic DIP





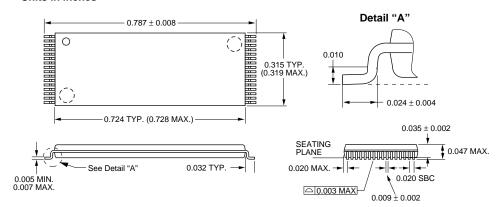


32-pin PLCC



32-pin TSOP-I

Units in inches



WORLDWIDE OFFICES

V29C51000T/V29C51000B

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